



# **SPECIFICATION**

(Reference sheet)

· Supplier : Samsung electro-mechanics · Samsung P/N : CL10A335MQ8NNNC

Product : Multi-layer Ceramic Capacitor

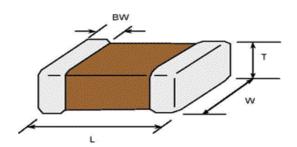
Description : CAP, 3.3uF, 6.3V, ±20%, X5R, 0603

### A. Samsung Part Number

<u>CL</u> <u>10</u> <u>A</u> <u>335</u> <u>M</u> <u>Q</u> <u>8</u> <u>N</u> <u>N</u> <u>N</u> <u>C</u> 1 2 3 4 5 6 7 8 9 10 11

| 1   | Series        | Samsung Multi-layer Ceramic Capacitor |         |                 |    |                 |              |
|-----|---------------|---------------------------------------|---------|-----------------|----|-----------------|--------------|
| 2   | Size          | 0603 (inch code)                      | L: 1.60 | ± 0.10 mm       | W: | $0.80 \pm 0.10$ | mm           |
| 3   | Dielectric    | X5R                                   | 8       | Inner electrode |    | Ni              |              |
| 4   | Capacitance   | 3.3 uF                                |         | Termination     |    | Cu              |              |
| (5) | Capacitance   | ±20 %                                 |         | Plating         |    | Sn 100%         | (Pb Free)    |
|     | tolerance     |                                       | 9       | Product         |    | Normal          |              |
| 6   | Rated Voltage | 6.3 V                                 | 10      | Special         |    | Reserved for    | future use   |
| 7   | Thickness     | $0.80 \pm 0.10$ mm                    | 11)     | Packaging       |    | Cardboard T     | ype, 7" reel |

#### **B. Structure & Dimension**



| Samsung P/N     | Dimension(mm) |             |             |             |  |  |
|-----------------|---------------|-------------|-------------|-------------|--|--|
| Samsung F/N     | L             | W           | Т           | BW          |  |  |
| CL10A335MQ8NNNC | 1.60 ± 0.10   | 0.80 ± 0.10 | 0.80 ± 0.10 | 0.30 ± 0.20 |  |  |

#### C. Samsung Reliablility Test and Judgement Condition

|                   | Judgement  | Test condition  |  |  |
|-------------------|--|---|--|--|
| Capacitance       | Within specified tolerance   | 1kHz ±10% / 1.0±0.2Vrms   |  |  |
| Tan δ (DF)        | 0.1 max.   | *A capacitor prior to measuring the capacitance is heat treated at 150°C+0/-10°C for 1 hour and maintained in ambient air for 24±2 hours. |  |  |
| Insulation        | 10,000Mohm or 100Mohm× <i>µ</i> F                                      | Rated Voltage 60~120 sec.   |  |  |
| Resistance        | Whichever is smaller   |   |  |  |
| Appearance        | No abnormal exterior appearance  | Microscope (×10)  |  |  |
| Withstanding      | No dielectric breakdown or   | 250% of the rated voltage   |  |  |
| Voltage           | mechanical breakdown   |   |  |  |
| Temperature       | X5R  |   |  |  |
| Characteristics   | (From-55℃ to 85℃, Capacitance change s                                 | hould be within ±15%)   |  |  |
| Adhesive Strength | No peeling shall be occur on the                                       | 500g·f, for 10±1 sec.   |  |  |
| of Termination    | terminal electrode   |   |  |  |
| Bending Strength  | Capacitance change: within ±12.5%                                      | Bending to the limit (1mm)  |  |  |
|                   |  | with 1.0mm/sec.   |  |  |
| Solderability     | More than 75% of terminal surface                                      | SnAg3.0Cu0.5 solder   |  |  |
|                   | is to be soldered newly  | 245±5°C, 3±0.3sec.  |  |  |
|                   |  | (preheating : 80~120°C for 10~30sec.)   |  |  |
| Resistance to     | Capacitance change : within ±7.5%                                      | Solder pot : 270±5°C, 10±1sec.  |  |  |
| Soldering Heat    | Tan δ, IR : initial spec.  |   |  |  |
| Vibration Test    | Capacitance change : within $\pm$ 5% Tan $\delta$ , IR : initial spec. | Amplitude: 1.5mm From 10Hz to 55Hz (return: 1min.) 2hours × 3 direction (x, y, z)   |  |  |
| Moisture          | Capacitance change: within ±12.5%                                      | With rated voltage  |  |  |
| Resistance        | Tan δ: 0.125 max   | 40±2°C, 90~95%RH, 500+12/-0hrs  |  |  |
|                   | IR: 500Mohm or 12.5Mohm × $\mu$ F                                      |   |  |  |
|                   | Whichever is smaller   |   |  |  |
| High Temperature  | Capacitance change: within ±12.5%                                      | With 150% of the rated voltage  |  |  |
| Resistance        | Tan δ: 0.125 max   | Max. operating temperature  |  |  |
|                   | IR: 1,000Mohm or 25Mohm × $\mu$ F                                      | 1000+48/-0hrs   |  |  |
|                   | Whichever is smaller   |   |  |  |
| Temperature       | Capacitance change: within ±7.5%                                       | 1 cycle condition   |  |  |
| Cycling           | Tan δ, IR : initial spec.  | Min. operating temperature → 25°C   |  |  |
|                   |  | → Max. operating temperature → 25°C   |  |  |
|                   |  | 5 cycle test  |  |  |

X The reliability test condition can be replaced by the corresponding accelerated test condition.

## D. Recommended Soldering method:

Reflow ( Reflow Peak Temperature : 260+0/-5°C, 10sec. Max )



A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

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- Military equipment
- 5 Disaster prevention/crime prevention equipment
- Any other applications with the same as or similar complexity or reliability to the applications set forth above.